

Update Search

## EAST Search History

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L6	227819	mold\$3 with (cavit\$3 recess\$2 trench\$2 opening\$1)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/10/24 16:20
L7	97410	compress\$3 with mold\$3	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/10/24 16:44
L10	22954	mold\$3 with (chip\$1 device\$1 circuit\$3 die dice) with (encapsulat\$4 seal\$3)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/10/24 16:22
L25	348	6 same 7 same 10	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/10/24 16:45
L26	215	25 and @ad<"20040302"	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/10/24 16:45

# Update Search (Interference Search)

## EAST Search History

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L29	28467	mold\$3 with (cavit\$3 recess\$2 trench\$2 opening\$1)	US-PGPUB	OR	OFF	2006/10/24 17:19
L31	2414	29 same (compress\$3 with mold\$3)	US-PGPUB	OR	OFF	2006/10/24 17:21
L32	539	31 same (mold\$3 with (chip\$1 device\$1 circuit\$3 die dice))	US-PGPUB	OR	OFF	2006/10/24 17:22
L33	98	32.clm.	US-PGPUB	OR	OFF	2006/10/24 17:22